



Laser Decap (Control Semi, FATCAT) start to service!

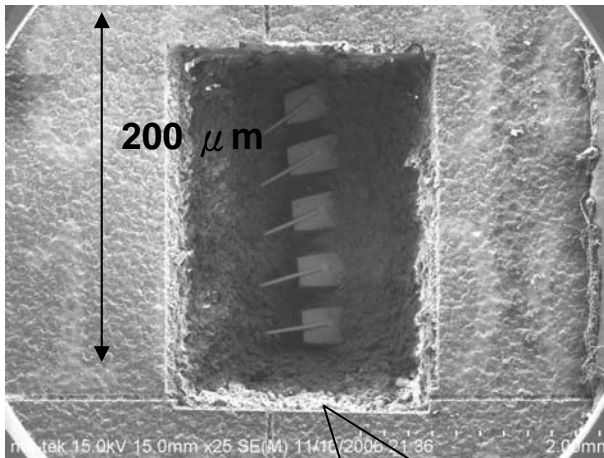
Case Log-in, please call

Ms. Midori Nakamura Tel: +886-952-350-603 or E-mail: midori@ma-tek.com

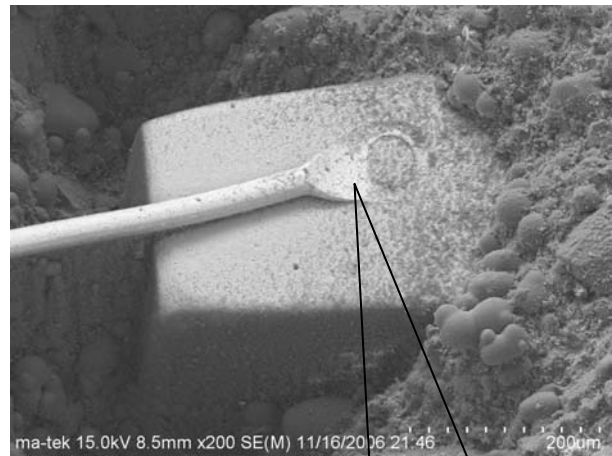
Mr. PS Kuo Tel: +886-952-303-815 or E-mail: pskuo@ma-tek.com

Potential applications:

1. Small area, selective decapsulation of SOP (small outline package)
2. Selective Decapsulation of IC Molding on Lead Frame
3. Direct cut-through of PCB board
4. Decapsulation of COF (Chip-on-Film)
5. Single wiring decapsulation



Selective opening the epoxy
by laser decap



check the 2nd bond quality

Cycle time guaranteed, upon receiving samples

1. Normal run, 3 working days
2. Urgent support, 1 day by request

You are highly welcome to use Fedex (account no. 2665-9953-6) , DHL (account no. 968368648) or UPS services for sample shipping. MA-tek pay the courier charge upon sample arrival.



Proprietary, DO NOT COPY WITHOUT PERMISSION

The content of this report is ONLY valid to the case of corresponding report number. Any page, or pages, of this report can not be used separately.

Page:

Date: